

2N2868

NPN HIGH-SPEED, HIGH-CURRENT SWITCH

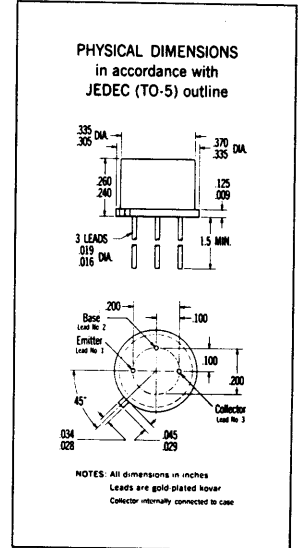
SILICON PLANAR EPITAXIAL TRANSISTORS

**FOR IMPROVED PERFORMANCE
SEE FAIRCHILD 2N3108, 2N3110**

GENERAL DESCRIPTION - The Fairchild 2N2868 is an NPN silicon PLANAR epitaxial transistor designed for use in high-speed, high current switching applications.

ABSOLUTE MAXIMUM RATINGS (Note 1)

Maximum Temperatures		
Storage Temperature		-65°C to +300°C
Operating Junction Temperature		200°C Maximum
Lead Temperature (Soldering, no time limit)		250°C Maximum
Maximum Power Dissipation		
Total Dissipation at 25°C Case Temperature	(Notes 2 and 3)	2.8 Watts
at 100°C Case Temperature	(Notes 2 and 3)	1.6 Watts
at 25°C Ambient Temperature	(Notes 2 and 3)	0.8 Watt
Maximum Voltages and Current		
V _{CBO} Collector to Base Voltage		60 Volts
V _{CEO} Collector to Emitter Voltage	(Note 4)	40 Volts
V _{EBO} Emitter to Base Voltage		7.0 Volts
I _C Collector Current		1.0 Amp



ELECTRICAL CHARACTERISTICS (25°C free air temperature unless otherwise noted)

Symbol	Characteristic	Min.	Max.	Units	Test Conditions
h _{FE}	DC Pulse Current Gain	(Note 5) 40	120		I _C = 150 mA V _{CE} = 10 V
h _{FE}	DC Pulse Current Gain	(Note 5) 30			I _C = 150 mA V _{CE} = 1.0 V
h _{FE}	DC Current Gain	30			I _C = 10 mA V _{CE} = 10 V
h _{FE}	DC Pulse Current Gain	(Note 5) 20			I _C = 500 mA V _{CE} = 10 V
h _{FE} (-55°C)	DC Current Gain	20			I _C = 10 mA V _{CE} = 10 V
V _{CE(sat)}	Collector Saturation Voltage		0.25	Volts	I _C = 150 mA I _B = 15 mA
V _{BE(sat)}	Base Saturation Voltage		1.3	Volts	I _C = 150 mA I _B = 15 mA
h _{fe}	High Frequency Current Gain (f = 20 mc)	2.5			I _C = 50 mA V _{CE} = 10 V
I _{CBO}	Collector Cutoff Current		10	nA	V _{CB} = 30 V I _E = 0
I _{CBO} (150°C)	Collector Cutoff Current		15	μA	V _{CB} = 30 V I _E = 0
I _{EBO}	Emitter Cutoff Current		50	nA	V _{EB} = 5.0 V I _C = 0
I _{CEx}	Collector Cutoff Current		100	nA	V _{CE} = 30 V V _{EB} = 3.0 V
I _{EBX}	Emitter Cutoff Current		100	nA	V _{CE} = 30 V V _{EB} = 3.0 V
BV _{CBO}	Collector to Base Breakdown Voltage	60		Volts	I _C = 100 μA I _E = 0
V _{CEO(sust)}	Collector to Emitter Sustaining Voltage	(Notes 4 and 5) 40		Volts	I _C = 25 mA I _B = 0 (pulsed)
BV _{EBO}	Emitter to Base Breakdown Voltage	7.0		Volts	I _E = 100 μA I _C = 0
C _{ob}	Output Capacitance (f = 1.0 mc)		20	pf	V _{CB} = 10 V I _E = 0
τ _b	Base Stored Charge		2.0	μsec	See Figure I

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NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C and junction-to-case thermal resistance of 62.5°C/Watt (derating factor of 16 mW/°C); junction-to-ambient thermal resistance of 218°C/Watt (derating factor of 4.6 mW/°C).
- (4) This rating refers to a high-current point where collector-to-emitter voltage is lowest.
- (5) Pulse Conditions: length $\leq 300 \mu\text{sec}$; duty cycle $\leq 2\%$.

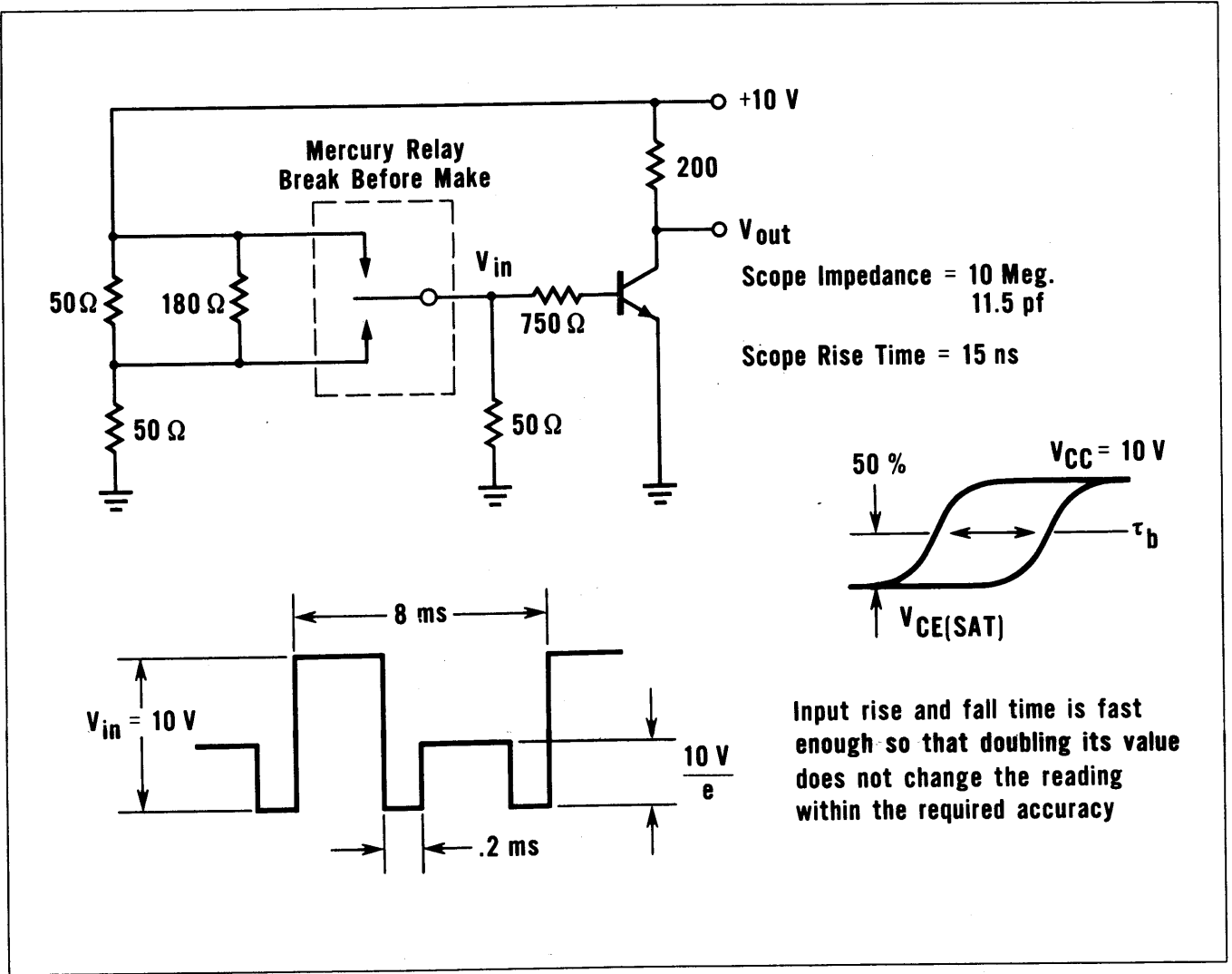


FIGURE 1

2N2890 • 2N2891 • 2N2892 • 2N2893

NPN HIGH-POWER, HIGH-VOLTAGE TYPE

DIFFUSED SILICON PLANAR EPITAXIAL TRANSISTORS

GENERAL DESCRIPTION — The 2N2892 and 2N2893 are 30-Watt* NPN silicon Planar epitaxial transistors designed for high-voltage, high-power amplifiers to 20 Mc; 12-, 24-, or 48-Volt DC converters; servo amplifiers; power supplies; and horizontal and vertical CRT output stages. High temperature operation is assured by the characteristic Planar low nanoamps leakage currents at high voltage. They are encased in a 1/16" hex power package.

The 2N2890 and 2N2891 are the same devices in the popular TO-5 package. Electrical characteristics are essentially the same except for lower current and power dissipation ratings.

* See power curves.

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures

	2N2890 2N2891	2N2892 2N2893
Storage Temperature	-65°C to +200°C	-65°C to +200°C
Operating Junction Temperature	200°C Maximum	200°C Maximum
Lead Temperature (Soldering, 60 sec. time limit)	300°C Maximum	300°C Maximum

Maximum Power Dissipation

Total Dissipation at	2N2890	2N2892
25°C Case Temperature [Notes 2 and 3]	5.0 Watts	30 Watts
at 100°C Case Temperature [Notes 2 and 3]	2.8 Watts	17 Watts
at 25°C Ambient Temperature [Notes 2 and 3]	0.8 Watt	

Maximum Voltages

	2N2890	2N2892
V _{CB0} Collector to Base Voltage	100 Volts	100 Volts
V _{CEO} Collector to Emitter Voltage [Note 4]	80 Volts	80 Volts
V _{EB0} Emitter to Base Voltage	5.0 Volts	5.0 Volts

ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted)

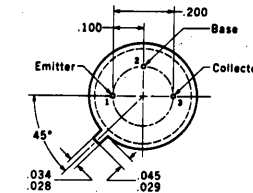
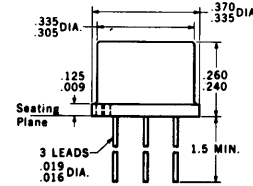
SYMBOL	CHARACTERISTIC	2N2891 2N2893			2N2890 2N2892			Units	TEST CONDITIONS
		Min.	Typ.	Max.	Min.	Typ.	Max.		
h _{FE}	DC Pulse Current Gain [Note 5]	50	80	150	30	55	90		I _C = 1.0 A V _{CE} = 2.0 V
h _{FE}	DC Pulse Current Gain [Note 5]	40	75		25	50			I _C = 2.0 A V _{CE} = 5.0 V
h _{FE}	DC Pulse Current Gain [Note 5]	35	80		20	55			I _C = 100 mA V _{CE} = 2.0 V
V _{CE} (sat)	Collector Saturation Voltage [pulsed, Notes 5 and 6]		0.2	0.5		0.2	0.5	Volts	I _C = 1.0 A I _B = 0.1 A
V _{CE} (sat)	Collector Saturation Voltage [pulsed, Notes 5 and 6]		0.35	0.75		0.35	0.75	Volts	I _C = 2.0 A I _B = 0.2 A
V _{BE} (sat)	Base Saturation Voltage [pulsed, Notes 5 and 6]		1.0	1.2		1.0	1.2	Volts	I _C = 1.0 A I _B = 0.1 A
V _{BE} (sat)	Base Saturation Voltage [pulsed, Notes 5 and 6]		1.1	1.3		1.1	1.3	Volts	I _C = 2.0 A I _B = 0.2 A
I _{CEX}	Collector Cutoff Current		2.0	100		2.0	100	nA	V _{CE} = 60 V V _{BE} = -2.0 V
I _{CEX} (150°C)	Collector Cutoff Current		7.0	100		7.0	100	μA	V _{CE} = 60 V V _{BE} = -2.0 V
I _{CEO}	Collector Cutoff Current		1.0	50		1.0	50	μA	I _B = 0 V _{CE} = 60 V
h _{fe}	Small Signal Current Gain (f = 1 Kc)	50	90		30	65			I _C = 50 mA V _{CE} = 10 V
h _{fe}	High Frequency Current Gain (f = 20 Mc)	1.5	2.5		1.5	2.3			I _C = 200 mA V _{CE} = 10 V
C _{obo}	Common Base, Open Circuit Output Capacitance		38	70		38	70	pf	I _E = 0 V _{CB} = 10 V

Additional Electrical Characteristics on page 2

Notes on page 2

PHYSICAL DIMENSIONS

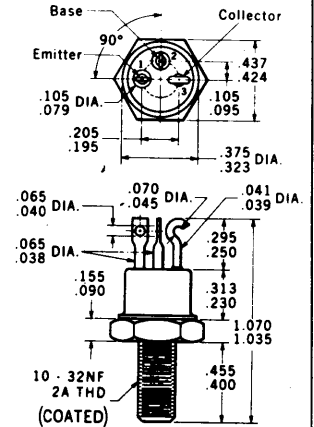
in accordance with
JEDEC (TO-5) outline



NOTES: All dimensions in inches
Leads are gold-plated brass
Collector internally connected to case
Package weight is 1.10 grams

2N2890 2N2891

PHYSICAL DIMENSIONS



HARDWARE

Flat nickel-plated brass washer
205 ID 475 OD .040 THICK
230 ID 505 OD .076 THICK
Flat mica washer (2)
185 ID 620 OD .003 THICK
205 ID 630 OD .008 THICK
Flat teflon spacer
185 ID 265 OD .035 THICK
205 ID 280 OD .055 THICK
Nickel-plated brass hex nut
10-32 American Standard double chamfered

NOTES: All dimensions in inches
Collector internally connected to case
Package weight is 6.07 grams

2N2892 2N2893

FAIRCHILD TRANSISTORS 2N2890 • 2N2891 • 2N2892 • 2N2893

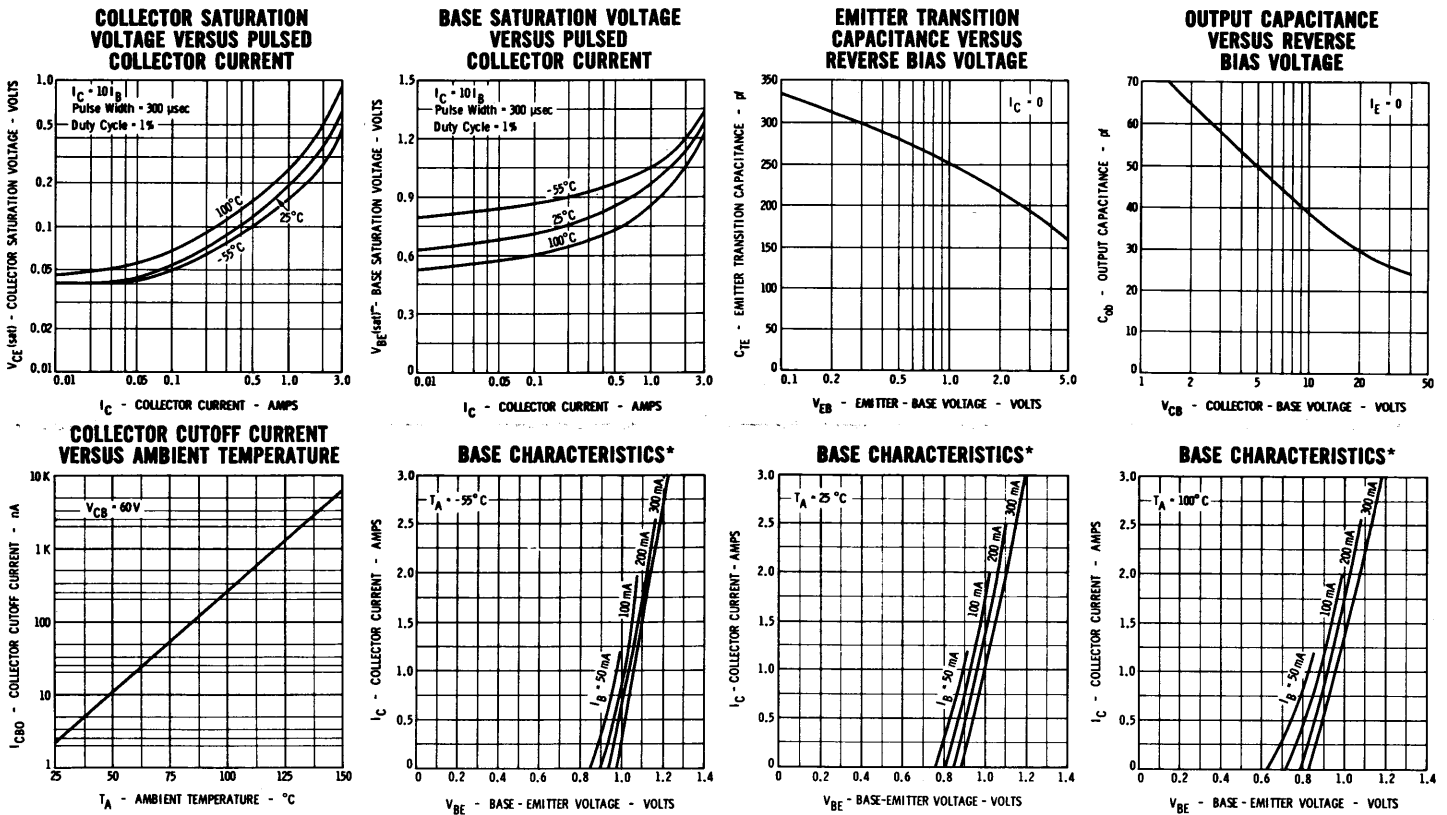
ELECTRICAL CHARACTERISTICS (25°C Free Air Temperature unless otherwise noted) (Continued)

SYMBOL	CHARACTERISTIC	2N2891 2N2893			2N2890 2N2892			Units	TEST CONDITIONS
		Min.	Typ.	Max.	Min.	Typ.	Max.		
BV_{CBO}	Collector to Base Breakdown Voltage	100			100			Volts	$I_C = 100 \mu A$ $I_E = 0$
V_{CEO} (sust)	Collector to Emitter Sustaining Voltage (Notes 4 and 5)	80			80			Volts	$I_C = 100 mA$ $I_B = 0$ (pulsed)
BV_{EBO}	Emitter to Base Breakdown Voltage	5.0			5.0			Volts	$I_C = 0$ $I_E = 10 \mu A$
t_{on}	Turn On Time [Note 7]			0.3			0.3	μsec	$I_C = 1.0 A$ $I_{B1} \approx 50 mA$
t_{off}	Turn Off Time [Note 7]			1.5			1.5	μsec	$I_C = 1.0 A$, $I_{B1} \approx 50 mA$ $I_{B2} \approx 50 mA$

NOTES:

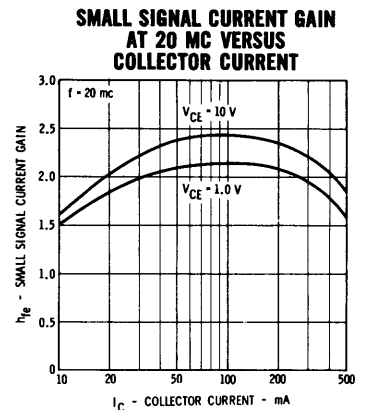
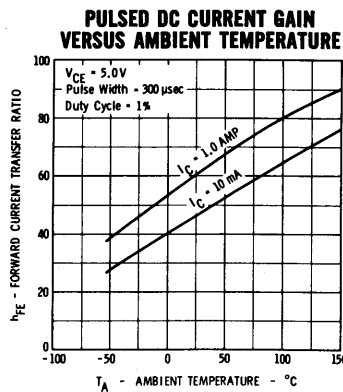
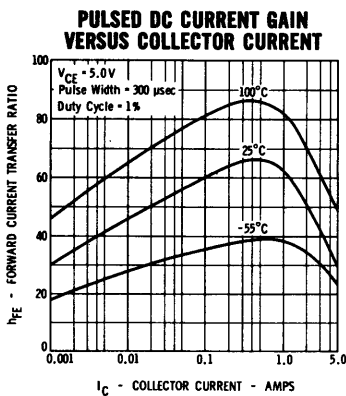
- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- (3) These ratings give a maximum junction temperature of 200°C. For the 2N2890 and 2N2891 junction-to-case thermal resistance of 35°C/Watt (derating factor of 28.6 mW/°C); junction-to-ambient thermal resistance of 219°C/Watt (derating factor of 4.56 mW/°C). See power curves for 2N2892 and 2N2893 ratings.
- (4) These ratings refer to a high-current point where collector-to-emitter voltage is lowest. For more information send for Fairchild Publication APP-4.
- (5) Pulse conditions: length = 300 μsec ; duty cycle = 1%.
- (6) Saturation voltages for 2N2890 and 2N2891 are measured with 1/4" lead length.
- (7) See switching circuit for exact I_{B1} and I_{B2} values.

TYPICAL ELECTRICAL CHARACTERISTICS



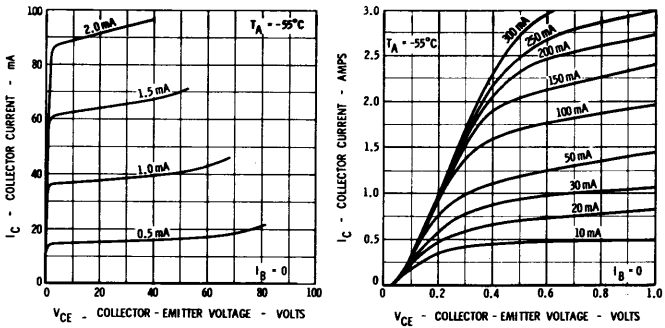
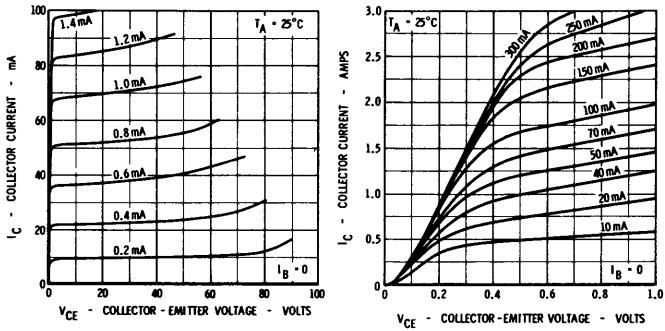
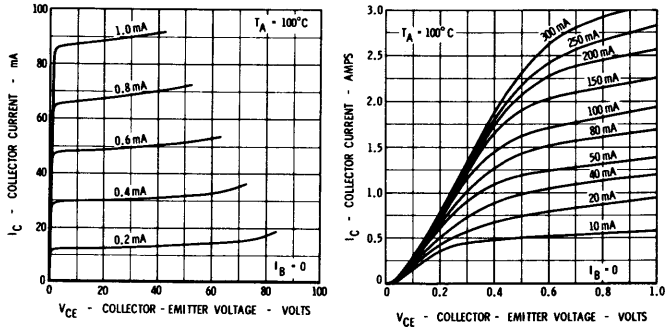
* Single family characteristic on Transistor Curve Tracer.

2N2890 • 2N2892



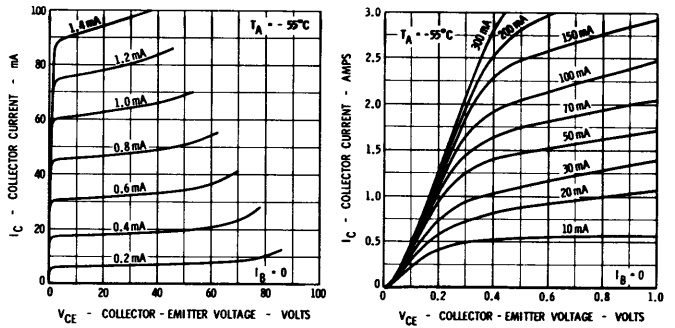
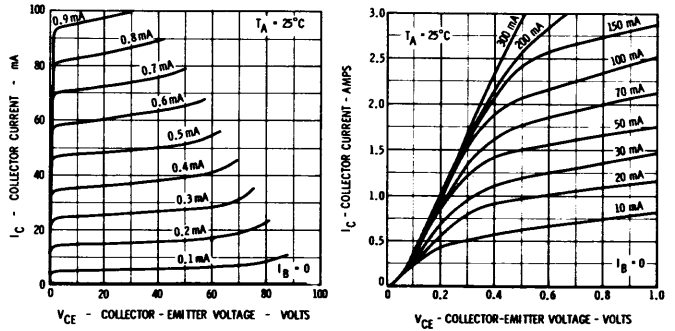
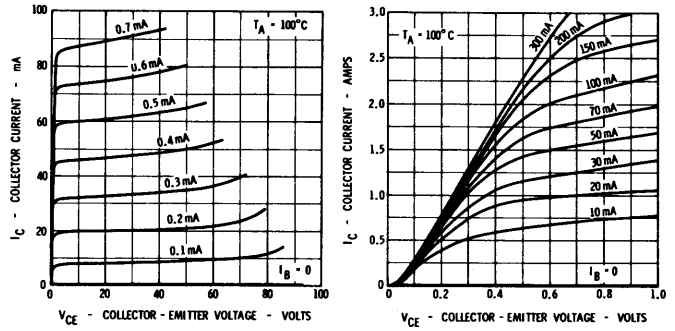
TYPICAL COLLECTOR CHARACTERISTICS*

2N2890 • 2N2892



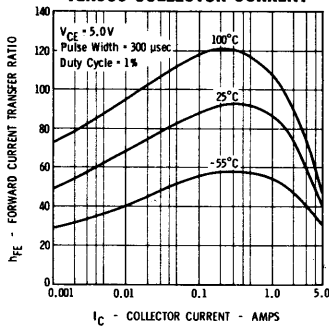
* Single family characteristic on Transistor Curve Tracer.

2N2891 • 2N2893

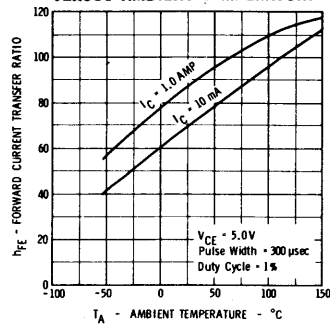


2N2891 • 2N2893

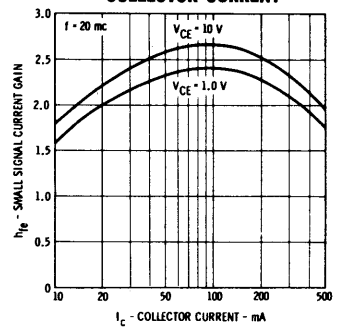
PULSED DC CURRENT GAIN VERSUS COLLECTOR CURRENT



PULSED DC CURRENT GAIN VERSUS AMBIENT TEMPERATURE



SMALL SIGNAL CURRENT GAIN AT 20 MC VERSUS COLLECTOR CURRENT



2N2980 • 2N2981 • 2N2982

NPN DIFFERENTIAL AMPLIFIERS

DIFFUSED SILICON PLANAR* TRANSISTORS

These six-terminal devices each contain two isolated high-gain NPN double-diffused silicon PLANAR transistors in one hermetically sealed enclosure. They are designed for use in high-performance differential amplifier circuits.

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures

Storage Temperature	-65°C to 300°C
Operating Junction Temperature	+200°C Maximum
Lead Temperature (Soldering, No Time Limit)	+300°C Maximum

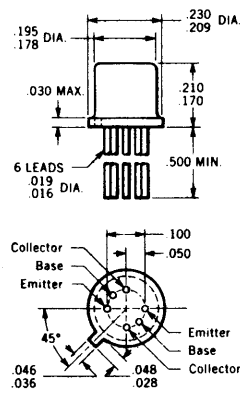
Maximum Power Dissipation

Total Dissipation at 25°C Case Temperature [Notes 2 and 3]	One Side	Both Sides
at 100°C Case Temperature [Notes 2 and 3]	0.5 Watt	0.75 Watt
at 25°C Ambient Temperature [Notes 2 and 3]	0.29 Watt	0.43 Watt
	0.25 Watt	0.30 Watt

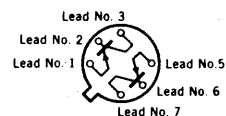
Maximum Voltages and Current for Each Transistor

V _{CB0}	Collector to Base Voltage	100 Volts
V _{CE0}	Collector to Emitter Voltage [Note 4]	60 Volts
V _{EB0}	Emitter to Base Voltage	7.0 Volts
I _C	Collector Current	500 mA

PHYSICAL DIMENSIONS



CONNECTION DIAGRAM



NOTES: All dimensions in inches
Leads are gold plated 40var
Package weight is 0.62 gram

ELECTRICAL CHARACTERISTICS (25°C free air temperature unless otherwise noted)

SYMBOL	CHARACTERISTIC	2N2980		2N2981		2N2982		UNITS	TEST CONDITIONS
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
$\frac{h_{FE1}}{h_{FE2}}$	DC Current Gain Ratio [Note 5]	0.9	1.0	0.8	1.0	0.9	1.0		I _C = 100 μA V _{CE} = 5.0 V
$\frac{h_{FE1}}{h_{FE2}}$	DC Current Gain Ratio [Note 5]	0.9	1.0						I _C = 1.0 mA V _{CE} = 5.0 V
V _{BE1} -V _{BE2}	Base-Emitter Voltage Differential	3.0		15		5.0		mV	I _C = 100 μA V _{CE} = 5.0 V
V _{BE1} -V _{BE2}	Base-Emitter Voltage Differential	5.0						mV	I _C = 1.0 mA V _{CE} = 5.0 V
Δ(V _{BE1} -V _{BE2})	Base-Emitter Voltage Differential Change (T _A = -55°C to +25°C or +25°C to +125°C)	10		25		15		μV/°C	I _C = 100 μA V _{CE} = 5.0 V
NF _f	Narrow Band Noise Figure (f = 1.0 kHz)	8.0						dB	I _C = 0.3 mA V _{CE} = 10 V B.W. = 200 Hz R _g = 510 Ω
NF	Broad Band Noise Figure (f = 25 Hz to 10 kHz)	8.0						dB	I _C = 0.3 mA V _{CE} = 10 V B.W. = 15.7 kHz R _g = 1.0 kΩ

* Planar is a patented Fairchild process.

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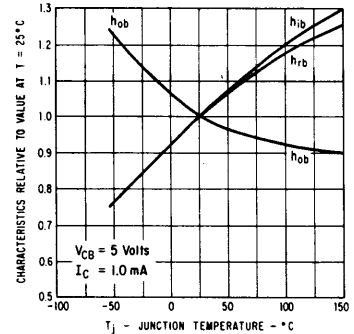
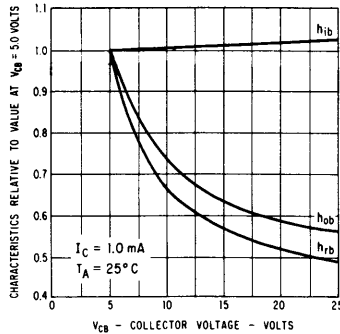
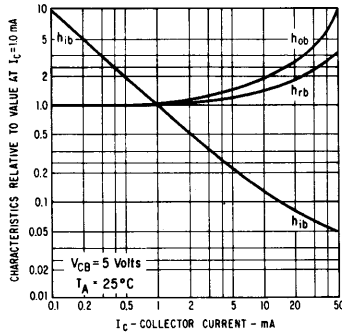
ELECTRICAL CHARACTERISTICS (25°C free air temperature unless otherwise specified)

SYMBOL	CHARACTERISTIC	2N2980			2N2981 2N2982			UNITS	TEST CONDITIONS
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
h_{FE}	DC Pulse Current Gain [Note 6]	50	100	150	50	125	200		$I_C = 10 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{FE}	DC Current Gain	40	80	120					$I_C = 1.0 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{FE}	DC Current Gain	30	60	90	25	60	150		$I_C = 100 \mu\text{A}$ $V_{CE} = 5.0 \text{ V}$
h_{FE}	DC Current Gain	25	50	75	15	50			$I_C = 10 \mu\text{A}$ $V_{CE} = 5.0 \text{ V}$
$V_{BE}(\text{sat})$	Base Saturation Voltage		0.7	0.9	0.7	0.9		Volts	$I_C = 50 \text{ mA}$ $I_B = 5.0 \text{ mA}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage	0.35	1.2		0.35	1.2		Volts	$I_C = 50 \text{ mA}$ $I_B = 5.0 \text{ mA}$
I_{CBO}	Collector Cutoff Current		0.4	2.0	0.4	10		nA	$I_E = 0$ $V_{CB} = 80 \text{ V}$
$I_{CBO}(150^\circ\text{C})$	Collector Cutoff Current		1.3	10	1.3	15		μA	$I_E = 0$ $V_{CB} = 80 \text{ V}$
BV_{CBO}	Collector to Base Breakdown Voltage	100			100			Volts	$I_C = 100 \mu\text{A}$ $I_E = 0$
$V_{CEO}(\text{sust})$	Collector to Emitter Sustaining Voltage [Notes 4 and 6]	60			60			Volts	$I_C = 30 \text{ mA}$ $I_B = 0$ (pulsed)
BV_{EBO}	Emitter Breakdown Voltage	7.0			7.0			Volts	$I_C = 0$ $I_E = 100 \mu\text{A}$
I_{EBO}	Emitter Cutoff Current		0.1	2.0	0.1	10		nA	$I_C = 0$ $V_{EB} = 5.0 \text{ V}$
h_{fe}	High Frequency Current Gain ($f = 20 \text{ MHz}$)	3.0	5.0		2.5	5.0			$I_C = 50 \text{ mA}$ $V_{CE} = 10 \text{ V}$
C_{ob0}	Output Capacitance	8.0	12	15	8.0	12	15	pF	$I_E = 0$ $V_{CB} = 10 \text{ V}$
C_{TE}	Emitter Transition Capacitance	30	60	85	30	60	85	pF	$I_C = 0$ $V_{EB} = 0.5 \text{ V}$

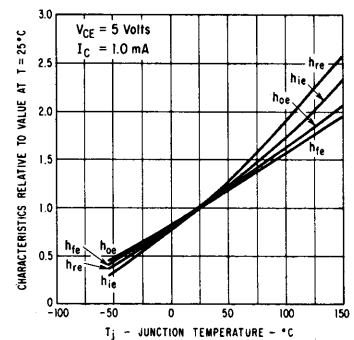
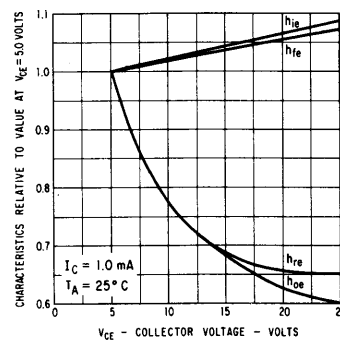
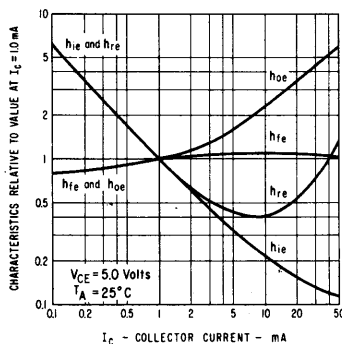
SMALL SIGNAL CHARACTERISTICS ($f = 1 \text{ kHz}$)

SYMBOL	CHARACTERISTIC	2N2980			2N2981 2N2982			UNITS	TEST CONDITIONS
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
h_{fe}	Small Signal Current Gain	50	80	150	40	125	200		$I_C = 1.0 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{ie}	Input Resistance	1.25	2.3	5.0	1.0		6.0	kohms	$I_C = 1.0 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{oe}	Output Conductance	5.0	9.0	20			30	μmhos	$I_C = 1.0 \text{ mA}$ $V_{CE} = 5.0 \text{ V}$
h_{ib}	Input Resistance	20	27	30	20	27	30	Ohms	$I_C = 1.0 \text{ mA}$ $V_{CB} = 5.0 \text{ V}$
h_{ob}	Output Conductance	0.1		0.5	0.1	0.2	0.5	μmhos	$I_C = 1.0 \text{ mA}$ $V_{CB} = 5.0 \text{ V}$
h_{rb}	Voltage Feedback Ratio			3.0		0.9	3.0	$\times 10^{-4}$	$I_C = 1.0 \text{ mA}$ $V_{CB} = 5.0 \text{ V}$

TYPICAL COMMON BASE CHARACTERISTICS

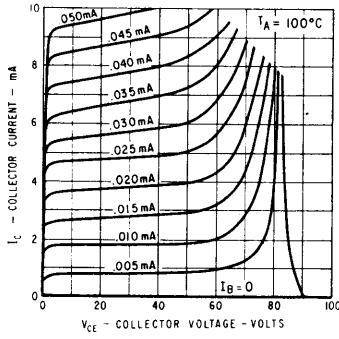


TYPICAL COMMON EMITTER CHARACTERISTICS

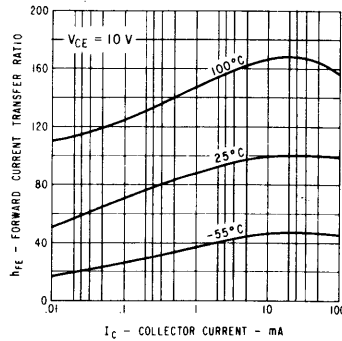


TYPICAL ELECTRICAL CHARACTERISTICS

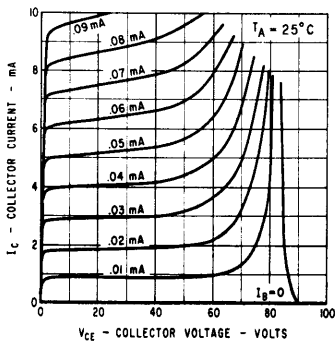
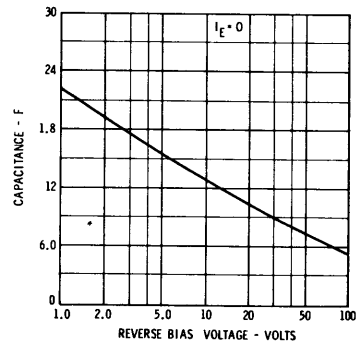
HIGH VOLTAGE COLLECTOR CHARACTERISTICS*



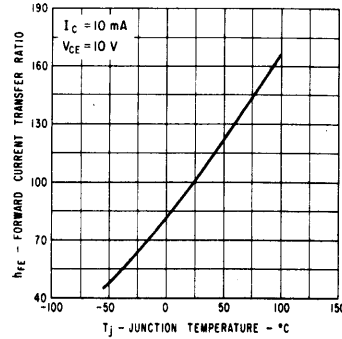
DC PULSE CURRENT GAIN VERSUS COLLECTOR CURRENT



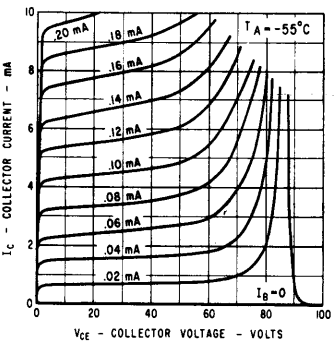
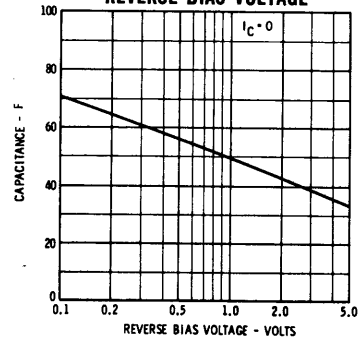
OUTPUT CAPACITANCE VERSUS REVERSE BIAS VOLTAGE



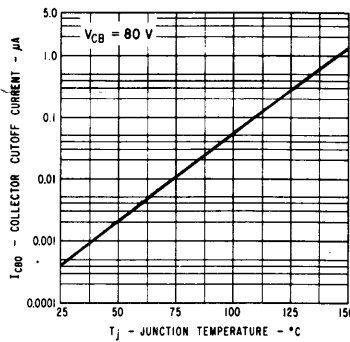
DC PULSE CURRENT GAIN VERSUS TEMPERATURE



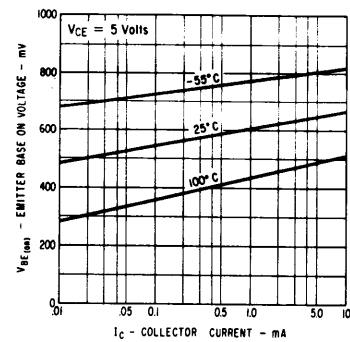
EMITTER TRANSITION CAPACITANCE VERSUS REVERSE BIAS VOLTAGE



COLLECTOR CUTOFF CURRENT VERSUS TEMPERATURE

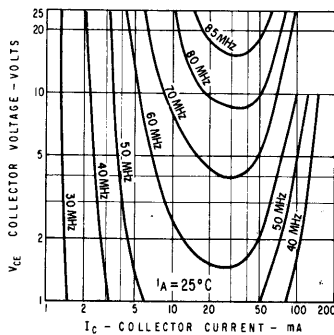


EMITTER-BASE ON VOLTAGE VERSUS COLLECTOR CURRENT

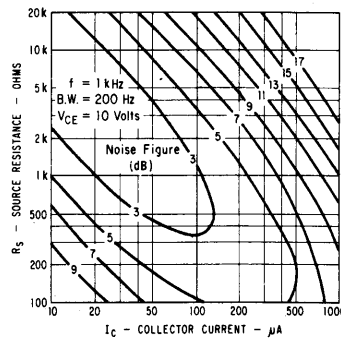


*Single family characteristics on Transistor Curve Tracer.

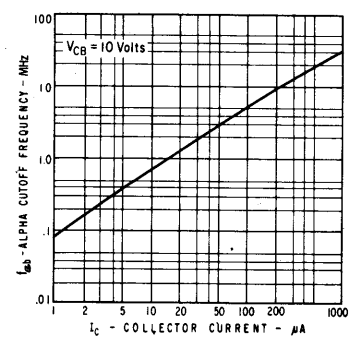
CONTOURS OF CONSTANT GAIN BANDWIDTH PRODUCT (f_T)

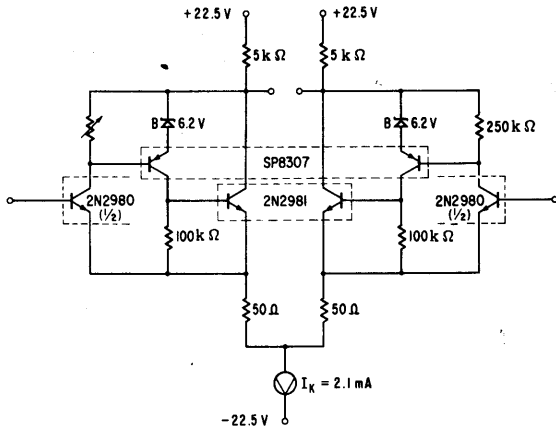


CONTOURS OF NARROW BAND NOISE FIGURE

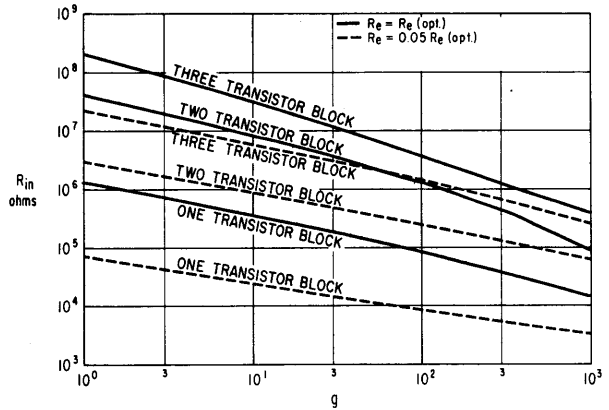


ALPHA CUTOFF FREQUENCY VERSUS COLLECTOR CURRENT

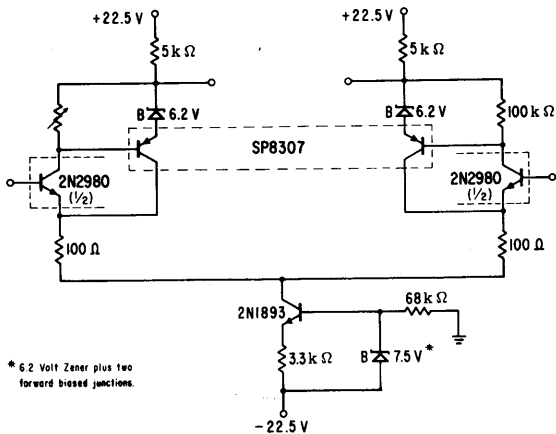




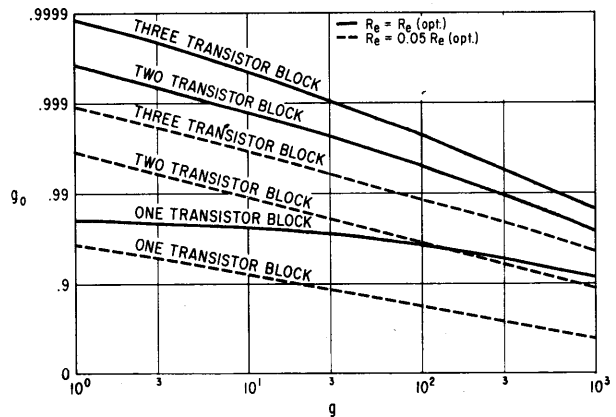
THE IMPROVED DIFFERENTIAL AMPLIFIER USING THE THREE-TRANSISTOR BLOCK.



INPUT RESISTANCE AS A FUNCTION OF g FOR $R_e = R_e$ (OPT.) AND $R_e = .05 R_e$ (OPT.)



THE IMPROVED DIFFERENTIAL AMPLIFIER USING THE TWO-TRANSISTOR BLOCK.



NORMALIZED GAIN, g_0 , AS A FUNCTION OF g ($g = R_e/R_e$) FOR $R_e = R_e$ (OPT.) AND $R_e = .05 R_e$ (OPT.)

For additional information on these and other differential amplifier circuits see Fairchild TP-16, APP-23, APP-45, and APP-60.

- NOTES:**
- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
 - (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
 - (3) These ratings give a maximum junction temperature of 200°C and junction-to-case thermal resistance of 350°C/watt (derating factor of 2.86 mW/°C) for one side; 233°C/watt (derating factor of 4.3 mW/°C) for both sides. Junction-to-ambient thermal resistance of 700°C/watt (derating factor of 1.43 mW/°C) for one side; 583°C/watt (derating factor of 1.72 mW/°C) for both sides.
 - (4) Rating refers to a high-current point where collector-to-emitter voltage is lowest.
 - (5) Lowest of the two h_{FE} readings is taken as h_{FE1} for purposes of this ratio.
 - (6) Pulse Conditions: length = 300 μ sec; duty cycle = 1%.

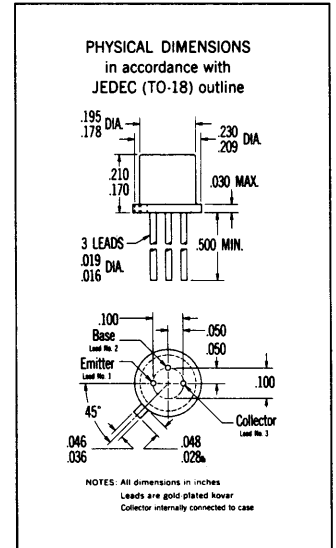
FT1746

FAIRCHILD PNP SILICON PLANAR EPITAXIAL TRANSISTOR HIGH-VOLTAGE, HIGH-FREQUENCY SWITCH AND RF AMPLIFIER

GENERAL DESCRIPTION - The FT1746 is a double-diffused silicon PNP PLANAR epitaxial transistor packaged in the JEDEC TO-18 outline. It is specifically designed for digital and analog applications requiring high-voltage and high-frequency characteristics in combination. Typical f_T is 150 mc.

ABSOLUTE MAXIMUM RATINGS [Note 1]

Maximum Temperatures		
Storage Temperature		-65°C to +200°C
Operating Junction Temperature		200°C Maximum
Soldering Temperature (60 seconds time limit)		300°C Maximum
Maximum Power Dissipation		
Total Dissipation at 25°C Case Temperature [Note 2 and 3]		1.2 Watts
at 100°C Case Temperature [Note 2 and 3]		0.68 Watt
at 25°C Ambient Temperature		0.36 Watt
Maximum Voltages		
V_{CBO} Collector to Base Voltage		-35 Volts
V_{CEO} Collector to Emitter Voltage		-30 Volts
V_{EBO} Emitter to Base Voltage		-4.0 Volts



ELECTRICAL CHARACTERISTICS (25°C unless otherwise noted)

Symbol	Characteristic	Min.	Max.	Units	Test Conditions
h_{FE}	DC Pulse Current Gain [Note 5]	20			$I_C = 10 \text{ mA}$ $V_{CE} = -5.0 \text{ V}$
$V_{BE}(\text{sat})$	Base Saturation Voltage		-1.0	Volts	$I_C = 10 \text{ mA}$ $I_B = 1.0 \text{ mA}$
$V_{CE}(\text{sat})$	Collector Saturation Voltage		-0.4	Volts	$I_C = 10 \text{ mA}$ $I_B = 1.0 \text{ mA}$
h_{fe}	High Frequency Current Gain ($f = 100 \text{ mc}$)	1.0			$I_C = 10 \text{ mA}$ $V_{CE} = -10 \text{ V}$
C_{ob}	Output Capacitance		9.0	pf	$I_E = 0$ $V_{CB} = -10 \text{ V}$
C_{TE}	Input Capacitance		11	pf	$I_C = 0$ $V_{EB} = -0.5 \text{ V}$
I_{CBO}	Collector Cutoff Current		5.0	nA	$I_E = 0$ $V_{CB} = -15 \text{ V}$
$I_{CBO}(150^\circ\text{C})$	Collector Cutoff Current		25	μA	$I_E = 0$ $V_{CB} = -15 \text{ V}$
BV_{CBO}	Collector to Base Breakdown Voltage	-35		Volts	$I_C = 10 \mu\text{A}$ $I_E = 0$
$V_{CEO}(\text{sust})$	Collector to Emitter Sustaining Voltage [Note 4]	-30		Volts	$I_C = 10 \text{ mA}$ $I_B = 0$ (pulsed)
BV_{EBO}	Emitter to Base Breakdown Voltage	-4.0		Volts	$I_C = 0$ $I_E = 10 \mu\text{A}$

NOTES:

- (1) These ratings are limiting values above which the serviceability of any individual semiconductor device may be impaired.
- (2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
- (3) These ratings give a maximum junction temperature of 200°C and junction-to-case thermal resistance of 146°C/Watt (derating factor of 6.9 mW/°C); junction-to-ambient thermal resistance of 486°C/Watt (derating factor of 2.1 mW/°C).
- (4) Rating refers to a high-current point where collector-to-emitter voltage is lowest.
- (5) Pulse conditions: length = 300 μsec ; duty cycle = 1%.

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